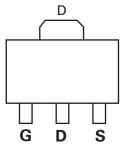


2SJ212-VB Datasheet

P-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | | |
| - 60 | 0.058 at V _{GS} = - 10 V | - 6.5 | 30 nC | | | | |
| - 60 | 0.065 at V _{GS} = - 4.5 V | - 5.5 | 30 110 | | | | |



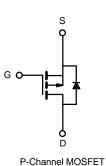
FEATURES

- Trench Power MOSFET 100
- % UIS Tested

APPLICATIONS

Load Switch





| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | | |
|--|-----------------------------------|-----------------|--------------------|------|--|--|
| Parameter | | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | - 60 | V | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | | | |
| | T _C = 25 °C | | - 6.5 ^a | | | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | | - 5.2 | | | |
| Continuous Drain Current $(T_j = 150^{\circ} C)$ | T _A = 25 °C | I _D | - 4.8 ^b | A | | |
| | T _A = 70 °C | | - 4.1 ^b | A | | |
| Pulsed Drain Current | I _{DM} | - 20 | | | | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | - 4.5 | | | |
| Single Pulse Avalanche Energy | L = 0.1 mm | E _{AS} | 10.1 | mJ | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | la la | 6.9 ^a | Α | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 3.5 ^b | A | | |
| | T _C = 25 °C | | 10.4 ^a | | | |
| Maximum Dawar Dissinction | T _C = 70 °C | Б | 6.6 ^a | w | | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.1 ^b | vv | | |
| | T _A = 70 °C | | 1.1 ^b | | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 33 | 40 | °C/W | | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.98 | 1.2 | | | |

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|--|-------|-------|-------|-------|
| Static | | | | • | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 60 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | 68 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | iD = - 200 μΛ | | - 5.2 | | mv/ C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.2 | | - 2.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA |
| Zara Cata Valtaga Drain Current | lana | $V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 1 | μA |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C | | | - 10 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 25 | | | А |
| | Р | V _{GS} = - 10 V, I _D = - 3 A | | 0.058 | | Ω |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$ | | 0.065 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 5 A | 20 | | | S |
| Dynamic ^b | | | | | | • |
| Input Capacitance | C _{iss} | | | 1500 | | |
| Output Capacitance | C _{oss} | V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz | | 200 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 150 | | |
| Total Gata Charge | 0 | $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -5 \text{ A}$ | | 38 | 56 | nC |
| Total Gate Charge | Qg | | | 19 | 30 | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 30 V, V_{GS} = - 4.5 V, I_D = - 5 A | | 9 | | |
| Gate-Drain Charge | Q _{gd} | | | 10 | | |
| Gate Resistance | Rg | f = 1 MHz | 5 | | | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | |
| Rise Time | t _r | V_{DD} = - 2 V, R_L = 2 Ω | | 7 | 15 | - ns |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 5 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 70 | 110 | |
| Fall Time | t _f | | | 40 | 60 | |
| Drain-Source Body Diode Characteristic | s | | | | | • |
| Continuous Source-Drain Diode Current | ا _S | T _C = 25 °C | | | - 6.9 | A |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 15 | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A | | - 1 | - 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 45 | 68 | ns |
| Body Diode Reverse Recovery Charge C Reverse Recovery Fall Time t | | | | 59 | 120 | nC |
| | | I _F = - 5 A, di/dt = 10 A/μs, T _J = 25 °C | | 29 | | |
| Reverse Recovery Rise Time | t _b | | | 16 | | ns |

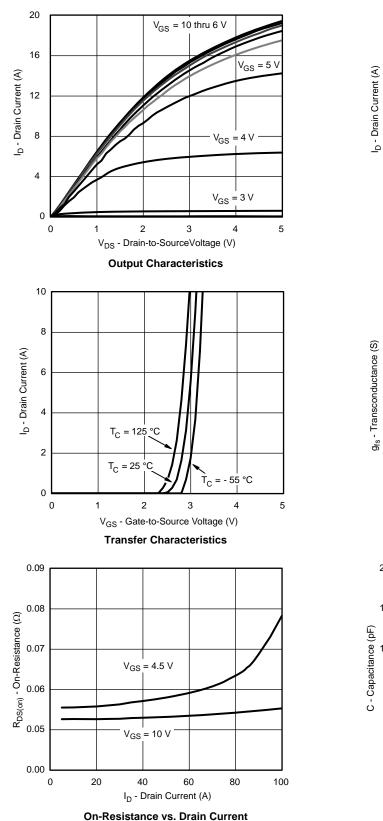
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

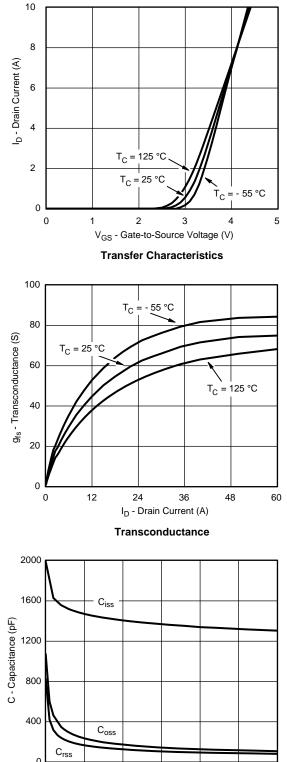
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





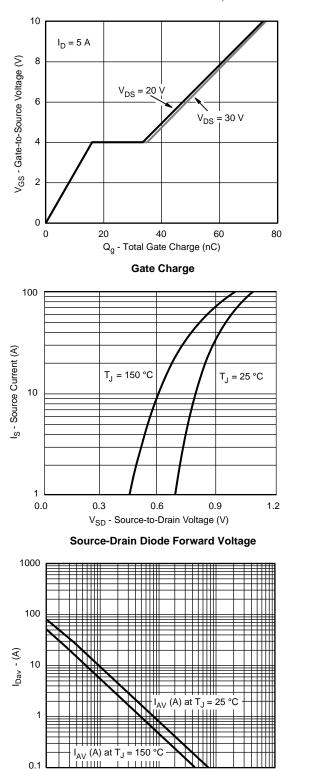
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



V_{DS} - Drain-to-Source Voltage (V) Capacitance

服务热线:400-655-8788





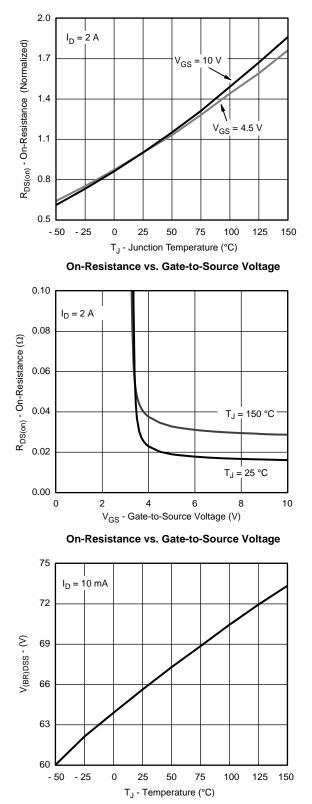
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{in} \text{ - } (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

0.1

1

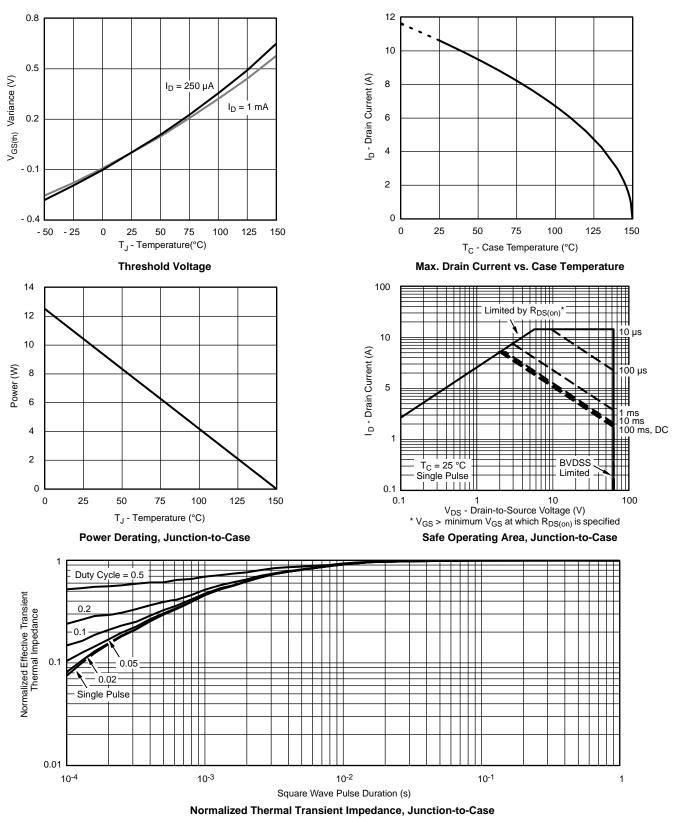


Drain-Source Breakdown Voltage vs. Junction Temperature

0.0001

0.001

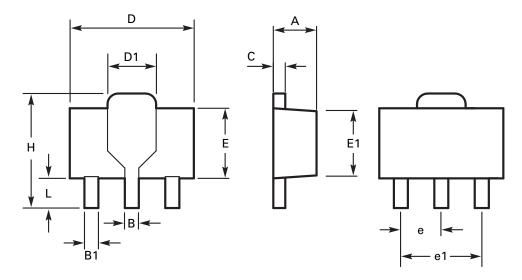




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Package outline - SOT89



| DIM | Millim | neters | Inc | Inches DIM Millimeters | | Inches | | Millimeters | | Millimeters | | Inches | |
|-----|--------|--------|-------|------------------------|----|----------|------|-------------|-------|-------------|--|--------|--|
| | Min | Max | Min | Max | | Min | Max | Min | Max | | | | |
| А | 1.40 | 1.60 | 0.550 | 0.630 | E | 2.29 | 2.60 | 0.090 | 0.102 | | | | |
| В | 0.44 | 0.56 | 0.017 | 0.022 | E1 | 2.13 | 2.29 | 0.084 | 0.090 | | | | |
| B1 | 0.36 | 0.48 | 0.014 | 0.019 | е | 1.50 BSC | | 0.059 BSC | | | | | |
| С | 0.35 | 0.44 | 0.014 | 0.017 e1 3.00 BSC 0.1 | | 3.00 BSC | | 0.118 | BSC | | | | |
| D | 4.40 | 4.60 | 0.173 | 0.181 | Н | 3.94 | 4.25 | 0.155 | 0.167 | | | | |
| D1 | 1.62 | 1.83 | 0.064 | 0.072 | L | 0.89 | 1.20 | 0.035 | 0.047 | | | | |

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches



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